

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit	: 1732	Customer No.:	035811
Examiner	: Robert C. Dye		
Serial No.	: 10/589,589		
Filed	: August 16, 2006		
Inventors	: Toshihide Sekido	Docket No.:	HIP-06-1238
	: Shigeo Iwasawa		
	: Tatsuya Senba	Confirmation No.:	2699
Title	: RTM MOLDING METHOD AND		
	: DEVICE	Dated:	September 2, 2009

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450


Sir:

The Applicants enclose Form PTO-1449 together with a copy of each of the three (3) listed non-US publications. The documents are submitted under 37 CFR §1.56.

Applicants certify that each item of information contained in the Supplemental Information Disclosure Statement was first cited in any communication from any foreign patent office in a counterpart foreign application not more than three months ago.

The Commissioner is authorized to charge the \$180 fee as well as any insufficiency to Deposit Account No. 50-2719. The Applicants respectfully request that this Supplemental Information Disclosure Statement be officially entered into the file and that appropriate notification be made that it was considered by the Examiner.

Respectfully submitted,


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